

MULTI-INNO TECHNOLOGY CO., LTD.

LCD MODULE SPECIFICATION

Model: MI12864AB-G-1

Revision	
Engineering	
Date	
Our Reference	



REVISION RECORD

Date	Ver.	Ref. Page	Revision No.	Revision Items
2003-7-2	1.0		1	Preliminary specification



1. General Specifications:

1.1 Display type: FSTN

1.2 Display color*¹:

Display color: Blue-Black

Background*2: White

1.3 Polarizer mode: Transflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/65 Duty 1/9 Bias

1.6 Backlight: LED (Dies on customer's board)

1.7 Controller: SSD1815BZ

1.8 Data Transfer: Serial

1.9 Operating Temperature: -20----+70 ℃

Storage Temperature: -30----+80 ℃

1.10 VDD: 2.8V

1.11 LCD Operating Voltage: 8.9V

1.12 Outline Dimensions: Refer to outline drawing on next page

1.13 Dot Matrix: 128 X 64 Dots

1.14 Dot Size: 0.184 X 0.285(mm) 1.15 Dot Pitch: 0.199 X 0.300(mm)

1.16 Weight: Approx 10g

^{*1} Color tone is slightly changed by temperature and driving voltage.

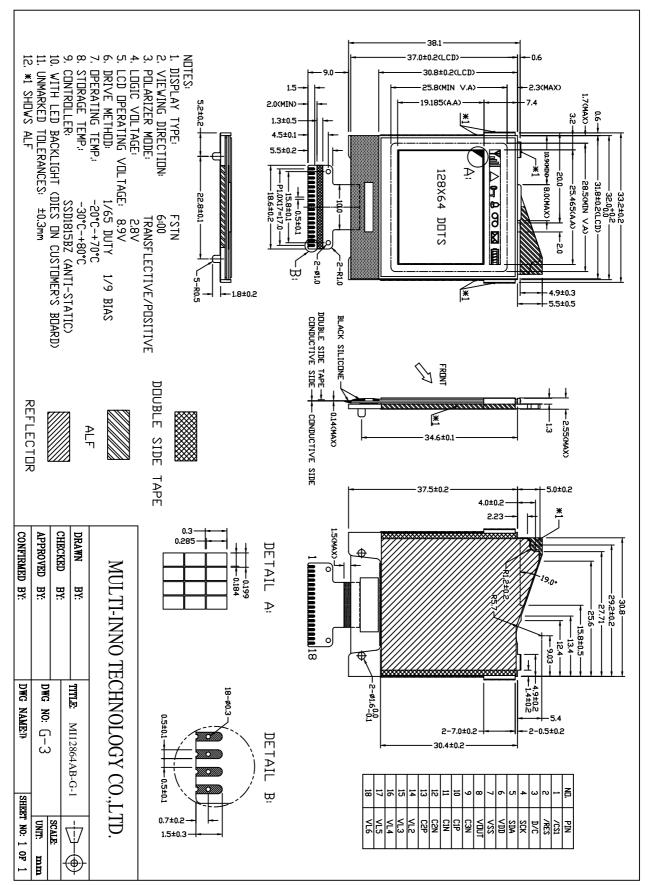
^{*2} Color tone will be changed by backlight.





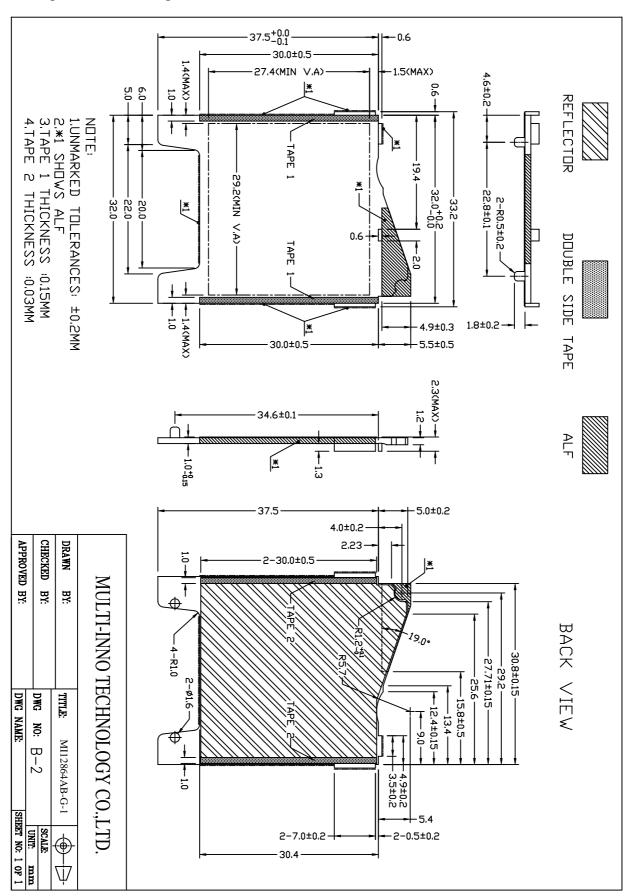
2. Outline Drawing

2.1 Outline Drawing of LCM



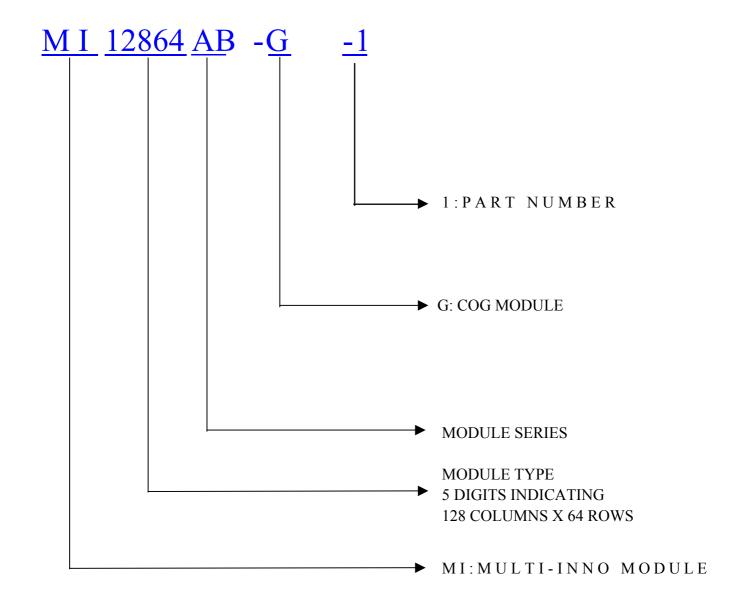


2.2 Light Guide Drawing





3. LCD Module Part Numbering System

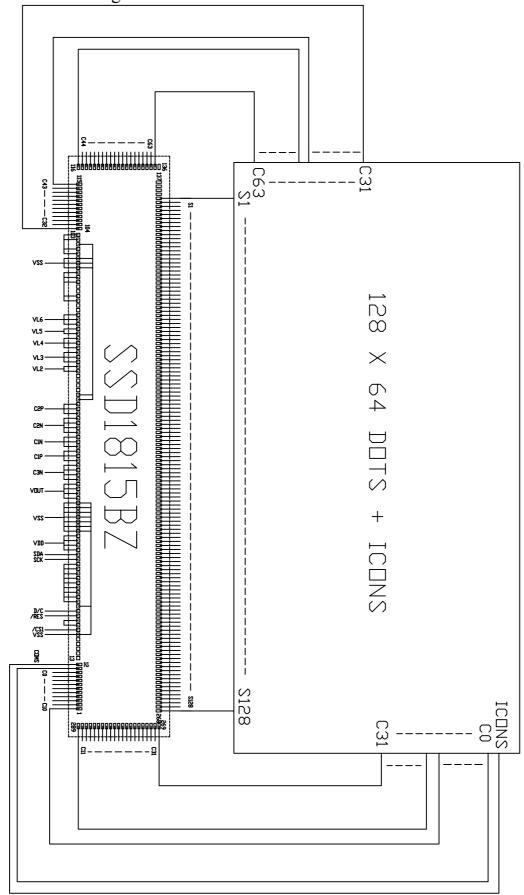






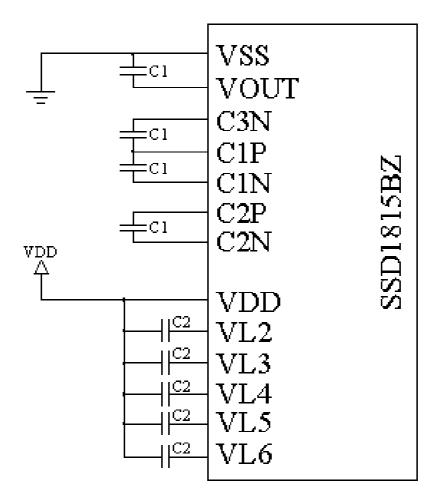
4. Circuit Block Diagram

4.1 Circuit Block Diagram





4.2 Power Supply Circuit



Reference Value: VDD=2.8V

C1=0.47\sigma 1.0uF/25V C2=0.1\sigma 0.47uF/25V



5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark	
Power Supply Voltage	V _{DD} -V _{SS}	-0.3	4.0	V		
LCD Driving Voltage	VLCD	4.0	12.0	V		
Operating Temperature Range	Тор	-20	+70	°C	No	
Storage Temperature Range	Тѕт	-30	+80		Condensation	



6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics

Item		Symbol	Min.	Тур.	Max.	Unit
Supply Voltage (Logic)		V _{DD} -V _{SS}	2.5	2.8	3.1	V
Supply Voltage (LCD Drive)		VLCD (VDD-VL6)	8.7	8.9	9.1	V
Input Signal Voltage	High	V_{IH} $(V_{\text{DD}}=2.8)$	$0.8V_{\mathrm{DD}}$	-	V_{DD}	V
	Low	V_{IL} $(V_{DD}=2.8)$	0	1	$0.2~\mathrm{V_{DD}}$	V
Supply current (Logic) (Display Character)		I_{DD} $(VDD-VSS = 2.8)$	-	-	300	uA



6.2 Interface Signals

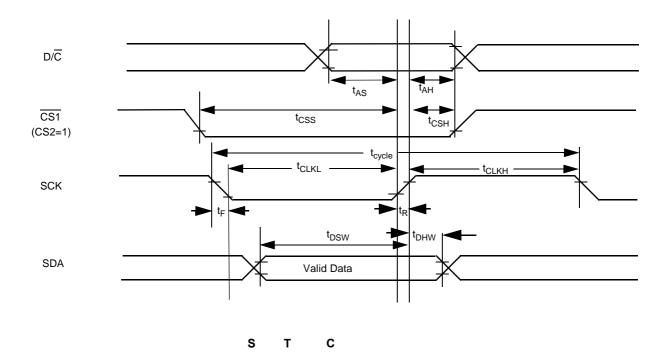
Pin No.	Symbol	Level	Description
1	/CS1	H/L	Chip select signal. " L " Active
2	/RES	H/L	Reset Signal. " L " -The settings are initialized
3	D/C	H/`L	Data/Command control signal. "H"-Indicates that SDA are display data "L"-Indicates that SDA are control data
4	SCK	H/L	Serial Clock Input Signal
5	SDA	H/L	Serial Data Input Signal
6	VDD	2.8V	Power supply for logic
7	VSS	0V	Ground
8	VOUT	-	DC-DC voltage converter output
9	C3N	-	Capacitor pin for voltage converter
10	C1P	-	Capacitor pin for voltage converter
11	C1N	-	Capacitor pin for voltage converter
12	C2N	-	Capacitor pin for voltage converter
13	C2P	-	Capacitor pin for voltage converter
14	VL2	-	Power supply voltage for LCD
15	VL3	-	Power supply voltage for LCD
16	VL4	-	Power supply voltage for LCD
17	VL5	-	Power supply voltage for LCD
18	VL6		Power supply voltage for LCD

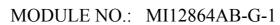


6.3 Interface Timing Chart

S	Т	С	(TA=25°C, DV _{DD} =2.7V, V _{SS} =0V)
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S	P	М	Т	М	U
t _{cycle}	Clock Cycle Time	400	-	-	ns
t _{AS}	Address Setup Time	250	-	-	ns
t _{AH}	Address Hold Time	250	-	-	ns
t _{CSS}	Chip Select Setup Time	250	-	-	ns
t _{CSH}	Chip Select Hold Time	250	-	-	ns
t _{DSW}	Write Data Setup Time	150	-	-	ns
t _{DHW}	Write Data Hold Time	150	-	-	ns
t _{CLKL}	Clock Low Time	150	-	-	ns
t _{CLKH}	Clock High Time	150	-	-	ns
t _R	Rise Time	-	-	15	ns
t _F	Fall Time	-	-	15	ns







6.4 Instruction Code

ВР	С	D					
0000X ₃ X ₂ X ₁ X ₀	Set Lower Column Address	Set the lower nibble of the column address register using $X_3X_2X_1X_0$ as data bits. The lower nibble of column address register is reset to 0000b after POR					
0001X ₃ X ₂ X ₁ X ₀	Set Higher Column Address	Set the higher nibble of the column address register using $X_3X_2X_1X_0$ as data bits. The higher nibble of column address is reset to 0000b after POR.					
00100X ₂ X ₁ X ₀	Set Internal Regulator Resistor Ratio	Feedback gain of the internal regulator generating V $_{L6}$ increases as $\rm X_2X_1X_0$ increased from 000b to 111b. After POR, $\rm X_2X_1X_0$ = 100b.					
00101X ₂ X ₁ X ₀	Set Power Control Register	X_0 =0: turns off the output op-amp buffer (POR) X_0 =1: turns on the output op-amp buffer X_1 =0: turns off the internal regulator (POR) X_1 =1: turns on the internal regulator X_2 =0: turns off the internal voltage booster (POR) X_2 =1: turns on the internal voltage booster					
01X ₅ X ₄ X ₃ X ₂ X ₁ X ₀	Set Display Start Line	Set GDDRAM display start line register from 0-63 using $X_5X_4X_3X_2X_1X_0$. Display start line register is reset to 000000 after POR.					
10000001 ** X ₅ X ₄ X ₃ X ₂ X ₁ X ₀	Set Contrast Control Register	Select contrast level from 64 contrast steps. Contrast increases (V $_{L6}$ decreases) as $X_5X_4X_3X_2X_1X_0$ is increased from 000000b to 111111b. $X_5X_4X_3X_2X_1X_0 = 100000$ b after POR					
1010000X ₀	Set Segment Re-map	X_0 =0: column address 00h is mapped to SEG0 (POR) X_0 =1: column address 83h is mapped to SEG0 Refer to Figure 8 on page 15 for example.					
1010001X ₀	Set LCD Bias	X_0 =0: POR default bias: 1/9 X_0 =1: alternate bias: 1/7 For other bias ratio settings, see " Set 1/4 Bias Ratio" and " Set Bias Ratio" in Extended Command Set.					
1010010X ₀	Set Entire Display On/Off	X_0 =0: normal display (POR) X_0 =1: entire display on					
1010011X ₀	Set Normal/Reverse Display	X_0 =0: normal display (POR) X_0 =1: reverse display					
1010111X ₀	Set Display On/Off	X_0 =0: turns off LCD panel (POR) X_0 =1: turns on LCD panel					
1011X ₃ X ₂ X ₁ X ₀	Set Page Address	Set GDDRAM Page Address (0-8) for read/write using X $_3$ X $_2$ X $_1$ X $_0$					
1100X ₃ ***	Set COM Output Scan Direction	X_3 =0: normal mode (POR) X_3 =1: remapped mode, COM0 to COM[N-1] becomes COM[N-1] to COM0 when Multiplex ratio is equal to N. See Figure 8 on page 15 for detail mapping.					
11100000	Set Read-Modify-Write Mode	Read-Modify-Write mode will be entered in which the column address will not be increased during display data read. After POR, Read-modify-write mode is turned OFF.					
11100010	Software Reset	Initialize internal status registers.					
11101110	Set End of Read-Modify-Write Mode	Exit Read-Modify-Write mode. RAM Column address before entering the mode will be restored. After POR, Read-modify-write mode is OFF.					



7. Optical Characteristics

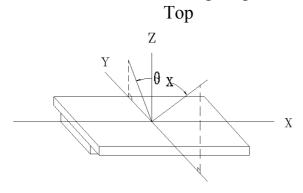
7.1 Optical Characteristics Ta=25°C

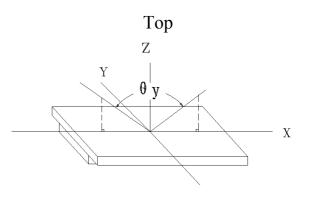
7.1 Optical	Charac	terrstres			1 a - 2	3 0			
Item		Symbol	Condition		Min.	Тур.	Max.	Unit	
		θ_{X}		θ _y =0°	-30		20		
Viewing A	Angle	ву	Cr≥2	θ _x =0°	-30		30	Deg	
Contrast 1	Ratio	Cr	$\theta_{x}=0^{\circ}$ $\theta_{y}=0^{\circ}$		3.0	-	-		
Tur on Response		Ton	θ_{X} =	θ _x =0°		-	300	ms	
Time	Turn off	Toff	$\theta_{x}=0^{\circ}$ $\theta_{y}=0^{\circ}$		-	1	300	ms	



7.2 Definition of Optical Characteristics

7.2.1 Definition of Viewing Angle

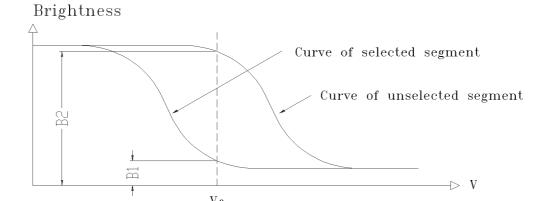




Bottom

7.2.2 Definition of Contrast Ratio

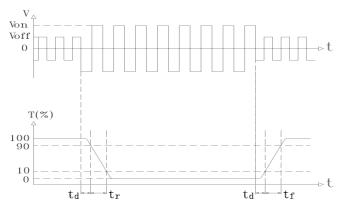
Bottom



Contrast Ratio = $B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$

Measuring Conditions:

1) Ambient Temperature: 25 °C; 2) Frame frequency: 84.0Hz 7.2.3 Definition of Response time



Turn on time: $t_{on} = t_d + t_r$

Turn off time: $t_{off} = t_d + t_f$

Measuring Condition:

1) Operating Voltage: 8.9V ;

2) Frame frequency: 84.0Hz



8. Reliability

8.1 Content of Reliability Test

Ta=25 °C

0.1	content of Renability	1031	1 a-25 C				
No.	Test Item	Content of Test	Test condition				
1	High Temperature	Endurance test applying the high	80°C 240H				
	Storage	storage temperature for a long time	Restore 4H at 25℃				
2	Low Temperature	Endurance test applying the low	-30°C 240H				
	Storage	storage temperature for a long time	Restore 4H at 25℃				
	High Temperature	Endurance test applying the high	60℃ 90%RH				
3	/Humidity Storage	temperature and high humidity	240H				
	Trummanty Storage	storage for a long time	Restore 4H at 25℃				
		Endurance test applying the low					
		and high temperature cycle					
4	Temperature	-30°C ←→25°C ←→80°C ←→25°C	10 cycles				
	Cycle	30min 5min 30min 5min ←———————————————————————————————————					
		1 cycle	Restore 4H at 25°C				
	Vibration Test	Endurance test applying the	10Hz~500Hz,				
5	(package state)	vibration during transportation	100m/s^2 ,				
	(package state)	vioration during transportation	120min				
	Shock Test	Endurance test applying the shock	Half- sine wave,				
6	(package state)	during transportation	300m/s^2 ,				
	(1)	<u> </u>	18ms				
	Atmospheric	Endurance test applying the	25kPa 16H				
7	Pressure Test	atmospheric pressure during	Restore 2H				
		transportation by air					



8.2 Failure Judgment Criterion

Criterion	Test Item No.							Failure Indoorent Critorian
Item	1	2	3	4	5	6	7	Failure Judgement Criterion
Basic Specification	1	1	1	1	1	1	1	Out of the basic Specification
Electrical specification	1	1	1					Out of the electrical specification
Mechanical Specification					1	1		Out of the mechanical specification
Optical Characteristic	1	V	1	1			1	Out of the optical specification
Note	Fo	For test item refer to 8.1						
Remark		Basic specification = Optical specification + Mechanical specification						



9. QUALITY LEVEL

Examination	At T _a =25°C		Inspection				
or Test	(unless otherwis	Min.	Max.	Unit	IL	AQL	
External Visual Inspection	Under illumination eyesight condit distance betwee and LCD is 25cm	en eyes	See Appendix A			II	Major 0.65 Minor 1.5
Display Defects	Under normal illumination and eyesight condition, display on inspection.		See Appendix B		II	Major 0.65 Minor 1.5	

MODULE NO.: MI12864AB-G-1

Note: Major defects: Open segment or common, Short, Serious damages, Leakage Miner defects: Others

Sampling standard conforms to GB2828

10. Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.





- 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: $0^{\circ}\text{C} \sim 40^{\circ}\text{C}$

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.



Appendix A

Inspection items and criteria for appearance defects

Items	Contents	Criteria				
Leakage		Not permitted				
Rainbow		According to the limit specimen				
Polarizer	Wrong polarizer attachment	Not permitted				
	Bubble between	Not counted		Max. 3 defects allowed		
	polarizer and glass	φ<0.3mm	0.3mm≤φ≤0.5i		mm	
	Scratches of polarizer	According to the limit specimen				
Black spot (in viewing area)	p	Not counted	Max. 3 spots allowed			
		X<0.2mm			Max. 3	
		X=(a+b)/2			spots (lines)	
Black line (in viewing area)	t b	Not counted	Max. 3 lines allowed		allowed	
		a<0.02mm	0.02mm≤a≤0.05mm b≤2.0mm			
Progressive cracks		Not permitted				



Appendix A

Inspection item and criteria for appearance defects (continued)

Items	Contents	Criteria		Criteria			
Glass	Cracks on pads	a	b	ı	c	Max. 2	
		≤3mm	$\leq V$	V/5	≤T/2	cracks	
	b ->-	≤2mm	≪V	V/5	T/2 <c<t< td=""><td>allowed</td></c<t<>	allowed	
	Cracks on contact side	a			b		
		≤3m	m		≤T/2		
		≤2m	2mm T/2 <b<t< td=""><td></td><td></td></b<t<>				
		C shall be not reach the seal area				Max. 2 cracks	Max. 5 cracks allowed
	Cracks on non-contact side	a		b		allowed	
	Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q Q	≤3m	m		≤T/2		
		≤2mm T/2<		Γ/2 <b<t< td=""><td></td><td></td></b<t<>			
		C≤0.5mm					
	2 "	d≤SW/3					
	Corner cracks	e<2.0mm ²			May 3		
	f-v	f<2.0mm	n^2			Max. 3 cracks allowed	
	f-v	1<2.0mm	1				



Appendix B

Inspection items and criteria for display defects

Items		Contents	Criteria			
Open segment or open common		Not permitted				
Short			Not permitted			
Wrong viewing angle			Not permitted			
Contrast radio uneven			According to the limit specimen			
Crosstalk			According to the limit specimen			
		+ + a	Not counted	Max.3 dots allowed		
		X<0.1mm	0.1mm≤X≤0.2mm			
Pin holes		X=(a+b)/2		Max.3 dots		
and cracks in segment		Not counted	Max.2 dots allowed	allowed		
(DOT)		A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm			
Black spot (in viewing area)			Not counted	Max.3 spots allowed	-	
		X<0.1mm	0.1mm≤X≤0.2mm			
		X=(a+b)/2	Max.3 spots			
Black line (in viewing area)	 	Not counted	Max.3 lines allowed	(lines) allowed		
		a<0.02mm	0.02mm≤a≤0.05mm b≤0.5mm			



Appendix B

Inspection items and criteria for display defects (continued)

Items	Content	Criteria			
	1 0	Not counted	Max. 2 defects allowed		
		x<0.1mm	0.1mm≤x≤0.2mm		
		x=(a+b)/2	,		
			Max.3 defects		
	D-++-a	Not counted	Max. 1 defects allowed	allowed	
Transformation of segment		a<0.1mm	0.1mm≤a≤0.2mm D>0		
		Max.2 defects 0.8W≤a≤1.2 a=measured va W=nominal va			